

## **Media Release**

# **UTAC Selected as Prime Supplier For European Cordless Chip Maker SiTel**

**SINGAPORE, 14 February 2006** – United Test and Assembly Centre Ltd (“UTAC” – SGX: UTAC), a leading independent global provider of semiconductor assembly and test services and SiTel Semiconductor B.V. (“SiTel”), a leading supplier of cordless voice and voice/data chips, signed a Memorandum of Understanding in which UTAC is chosen as the prime supplier of SiTel’s assembly and test requirements.

SiTel, which became independent from NYSE-listed National Semiconductor Corporation in June 2005, designs and sells high-quality chips for cordless phones and other cordless applications. SiTel has been developing chip-sets and even complete modules that form the heart of wireless products in the market for consumer electronics.

SiTel captured a global market share of more than 20% and more than 30% in the European market for DECT (“Digital Enhanced Cordless Technology”) in 2005. SiTel has customers in North America, Europe, Asia and Japan which include many high-profile organisations such as AT&T, V-Tech, Nortel, Uniden, Siemens, Ascom, Panasonic, Philips, DeTeWe and B&O. SiTel won the cordless gamepad market by exploiting the (real-time) advantages of its DECT technology.

This partnership will further reinforce the strategic alliance and cooperation between the two companies. UTAC will develop engineering solutions and perform full turnkey services for SiTel’s cordless chips. Test production commenced in January and the full turnkey production will start in the coming months.

According to Gartner's forecast for digital cordless phones in November 2004, the digital cordless communication market is expected to double from US\$1 billion in 2003 to more than US\$2 billion in 2008.

“This is a significant win for UTAC as the digital cordless communication market is poised to be a high-growth sector. It is also very much in line with our business growth strategy,” said Ms June Chia, Group Executive Vice President of UTAC. “Our partnership with SiTel reinforces our dedication towards expanding our product and services range to penetrate the wireless consumer products market for semiconductor test and assembly services and also clearly demonstrates our expertise in providing complete turnkey solutions for wireless consumer chip makers.

“In line with our strategy to further penetrate the digital cordless market, we require a partner who provides a seamless full turnkey solution to efficiently increase developmental speed ‘time-to-market’,” said Asmund Tielens, SiTel’s CEO. In addition, Jacques Theunissen, COO, said, “To fulfil this requirement, we sought a partner who offers a complete package with strong test capabilities to rapidly ramp up production when needed to meet global demand. We are happy that UTAC was able to meet all of those requirements.”

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## **About United Test and Assembly Center Ltd (“UTAC”)**

Established in 1997 and listed on the Main Board of the Singapore Exchange, UTAC is a leading independent provider of semiconductor assembly and testing services to its customers, which comprise integrated device manufacturers (“IDMs”), fabless companies and wafer foundries. UTAC provides wafer probing and final testing services on a diverse selection of test platforms for a range of semiconductors including memory, logic, mixed-signal and radio-frequency ICs. Besides testing services, UTAC also provides assembly services for a broad range of leadframe and array packages.

Headquartered in Singapore where it houses its manufacturing, test engineering and package design facilities, UTAC has established a global network of sales offices in the United States, Europe, Japan, Korea and China. It also has wholly-owned subsidiaries in China and Taiwan to provide wafer probing and testing services. For more information, visit [www.utacgroup.com](http://www.utacgroup.com)

## **About SiTel Semiconductor B.V**

SiTel Semiconductor BV was established in June 2005 after a management buy-out from National Semiconductor Corporation. SiTel Semiconductor BV is a specialist in the field of design, manufacturing and marketing of high-performance digital cordless communication ICs. The company’s leading-edge products include CMOS RF and baseband ICs, including voice/data modules with embedded software. SiTel’s products target a large range of cordless applications from basic up to high-end. These applications include cordless phones, conference phones, PABX products, headsets, set-top boxes, home entertainment systems and cordless gamepads.

SiTel has its headquarters in ‘s-Hertogenbosch, and a satellite design centre in Hengelo, the Netherlands, with regional sales offices in Hong Kong, Japan and (soon) the U.S. SiTel strives to become the world’s number one supplier for digital cordless communication ICs. For more information, visit [www.sitelsemi.com](http://www.sitelsemi.com)

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